



Part Number : [1706732108](#)
Product Description : EdgeLine Vertical Connector,
12.5 Gbps, 0.80mm Pitch, 1.57mm PCB Thickness, 2
Bays, 108 Circuits
Series Number : 170673
Status : Active
Product Category : Card Edge Connectors



Documents and Resources

Drawings

- [1706732108_sd.pdf](#)
- [PK-76693-900-001.pdf](#)
- [SYM-170673-2108-001.zip](#)
- [1706730002-000.pdf](#)

Specifications

- [AS-76693-100-001.pdf](#)
- [AS-76693-101-001.pdf](#)
- [PS-75594-999-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC

- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	Card Edge Connectors
Series	170673
Description	EdgeLine Vertical Connector, 12.5 Gbps, 0.80mm Pitch, 1.57mm PCB Thickness, 2 Bays, 108 Circuits
Component Type	Edgecard to PCB
Product Name	EdgeLine
UPC	884982404571

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.5A
Data Rate	12.5-20.0 Gbps
High Power Bay (30.0A or more)	No
Voltage - Maximum	250V AC

Physical

Circuits (Loaded)	108
-------------------	-----

Circuits (maximum)	108
Color - Resin	Black
Durability (mating cycles max)	200
Edge Card Thickness	1.57mm
Entry Angle	N/A
Flammability	94V-0
Keying to Mating Part	N/A
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	4.452/g
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Thickness - Recommended	2.79mm
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Plating min - Mating	0.762µm
Plating min - Termination	0.762µm
Polarized to Mating Part	Yes
(p)ower-(s)ignal Configuration	108s - 0p
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole - Compliant Pin

Solder Process Data

Lead-Free Process Capability	N/A
------------------------------	-----